

### General Description

The 75N04 uses innovative packaging technology to provide excellent RDS(ON). This device is suitable for use as a wide variety of applications.

### Features

- N-channel Enhancement mode
- Low On-Resistance
- 100% Avalanche tested
- RoHS Compliant

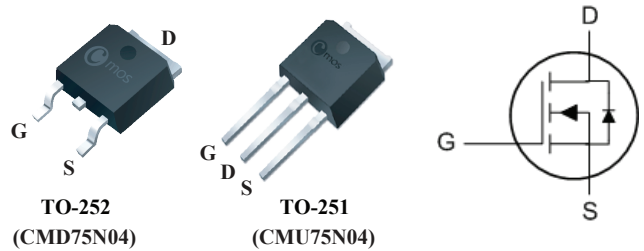
### Product Summary

| BVDSS | RDSON | ID  |
|-------|-------|-----|
| 40V   | 7.5mΩ | 75A |

### Applications

- DC/DC converter
- Powertrain Management
- Solenoid and Motor Drivers

### TO-252/251 Pin Configuration



### Absolute Maximum Ratings

| Symbol                | Parameter                            | Rating     | Units      |
|-----------------------|--------------------------------------|------------|------------|
| $V_{DS}$              | Drain-Source Voltage                 | 40         | V          |
| $V_{GS}$              | Gate-Source Voltage                  | $\pm 20$   | V          |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current             | 75         | A          |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current             | 53         | A          |
| $I_{DM}$              | Pulsed Drain Current                 | 300        | A          |
| EAS                   | Single Pulse Avalanche Energy        | 200        | mJ         |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation              | 60         | W          |
| $T_{STG}$             | Storage Temperature Range            | -55 to 175 | $^\circ C$ |
| $T_J$                 | Operating Junction Temperature Range | -55 to 175 | $^\circ C$ |

### Thermal Data

| Symbol          | Parameter                           | Typ. | Max. | Unit         |
|-----------------|-------------------------------------|------|------|--------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient | ---  | 62   | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction -Case   | ---  | 2.6  | $^\circ C/W$ |

**Electrical Characteristics (T<sub>J</sub>=25°C , unless otherwise noted)**

| Symbol              | Parameter                         | Conditions  | Min. | Typ. | Max. | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage    | V <sub>GS</sub> =0V , I <sub>D</sub> =250μA   | 40   | ---  | ---  | V    |
| R <sub>DS(ON)</sub> | Static Drain-Source On-Resistance | V <sub>GS</sub> =10V , I <sub>D</sub> =20A  | ---  | 6.5  | 7.5  | mΩ   |
|                     |                                   | V <sub>GS</sub> =4.5V , I <sub>D</sub> =20A   | ---  | 8    | 11   |      |
| V <sub>GS(th)</sub> | Gate Threshold Voltage            | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA                                  | 1    | ---  | 3    | V    |
| I <sub>DSS</sub>    | Drain-Source Leakage Current      | V <sub>DS</sub> =40V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C                         | ---  | ---  | 1    | μA   |
|                     |                                   | V <sub>DS</sub> =18V , V <sub>GS</sub> =0V , T <sub>J</sub> =85°C                         | ---  | ---  | 20   |      |
| I <sub>GSS</sub>    | Gate-Source Leakage Current       | V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V   | ---  | ---  | ±100 | nA   |
| g <sub>fs</sub>     | Forward Transconductance          | V <sub>DS</sub> =5 V , I <sub>D</sub> =20A  | ---  | 30   | ---  | S    |
| R <sub>g</sub>      | Gate Resistance                   | V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz  | ---  | 2    | ---  | Ω    |
| Q <sub>g</sub>      | Total Gate Charge                 | V <sub>DD</sub> =32V , V <sub>GS</sub> =0 to 10V , I <sub>D</sub> =75A                    | ---  | 25   | 33   | nC   |
| Q <sub>gs</sub>     | Gate-Source Charge                |   | ---  | 12   | ---  |      |
| Q <sub>gd</sub>     | Gate-Drain Charge                 |   | ---  | 3.5  | ---  |      |
| T <sub>d(on)</sub>  | Turn-On Delay Time                | V <sub>DD</sub> =20V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.5Ω<br>I <sub>D</sub> =75A | ---  | 7    | ---  | ns   |
| T <sub>r</sub>      | Rise Time                         |   | ---  | 10   | ---  |      |
| T <sub>d(off)</sub> | Turn-Off Delay Time               |   | ---  | 6    | ---  |      |
| T <sub>f</sub>      | Fall Time                         |   | ---  | 8    | ---  |      |
| C <sub>iss</sub>    | Input Capacitance                 | V <sub>DS</sub> =25V , V <sub>GS</sub> =0V , f=1MHz                                       | ---  | 2400 | ---  | pF   |
| C <sub>oss</sub>    | Output Capacitance                |   | ---  | 490  | ---  |      |
| C <sub>rss</sub>    | Reverse Transfer Capacitance      |   | ---  | 15   | ---  |      |

**Diode Characteristics**

| Symbol          | Parameter             | Conditions                                 | Min. | Typ. | Max. | Unit |
|-----------------|-----------------------|--|------|------|------|------|
| V <sub>SD</sub> | Diode Forward Voltage | V <sub>GS</sub> =0V , I <sub>F</sub> = 20A | ---  | ---  | 1.2  | V    |

Note :

1.The test condition is V<sub>DD</sub>=20V,V<sub>GS</sub>=10V,L=0.5mH,I<sub>AS</sub>=28A

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